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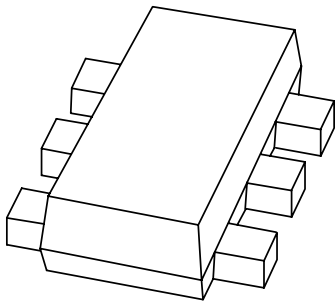
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Kind regards,

Team Nexperia

# DATA SHEET



**PBSS4240V**

40 V low  $V_{CEsat}$  NPN transistor

Product data sheet

2003 Jan 30

40 V low  $V_{CEsat}$  NPN transistor

PBSS4240V

FEATURES

- Low collector-emitter saturation voltage  $V_{CEsat}$
- High collector current capability  $I_C$  and  $I_{CM}$
- High collector current gain ( $h_{FE}$ ) at high  $I_C$
- High efficiency leading to reduced heat generation
- Reduced printed-circuit board area requirements.

APPLICATIONS

- Power management:
  - DC-DC converter
  - Supply line switching
  - Battery charger
  - LCD back lighting.
- Peripheral driver:
  - Driver in low supply voltage applications (e.g. lamps and LEDs)
  - Inductive load drivers (e.g. relay, buzzers and motors).

DESCRIPTION

NPN transistor providing low  $V_{CEsat}$  and high current capability in a SOT666 plastic package.  
PNP complement: PBSS5240V.

MARKING

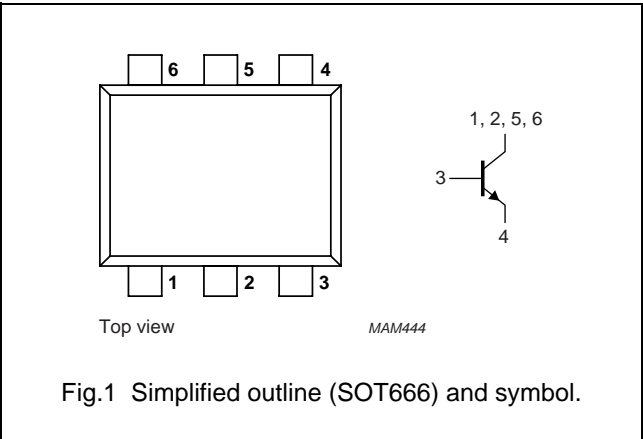
| TYPE NUMBER | MARKING CODE |
|-------------|--------------|
| PBSS4240V   | 42           |

QUICK REFERENCE DATA

| SYMBOL      | PARAMETER                 | MAX. | UNIT       |
|-------------|---------------------------|------|------------|
| $V_{CEO}$   | collector-emitter voltage | 40   | V          |
| $I_C$       | collector current (DC)    | 2    | A          |
| $I_{CRP}$   | peak collector current    | 2    | A          |
| $R_{CEsat}$ | equivalent on-resistance  | <190 | m $\Omega$ |

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | collector   |
| 2   | collector   |
| 3   | base        |
| 4   | emitter     |
| 5   | collector   |
| 6   | collector   |



40 V low  $V_{CEsat}$  NPN transistor

## PBSS4240V

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL    | PARAMETER                         | CONDITIONS                                  | MIN. | MAX. | UNIT |
|-----------|-----------------------------------|---|------|------|------|
| $V_{CBO}$ | collector-base voltage            | open emitter                                | –    | 40   | V    |
| $V_{CEO}$ | collector-emitter voltage         | open base                                   | –    | 40   | V    |
| $V_{EBO}$ | emitter-base voltage              | open collector                              | –    | 5    | V    |
| $I_C$     | collector current (DC)            | note 1                                      | –    | 2    | A    |
| $I_{CRP}$ | repetitive peak collector current | note 2                                      | –    | 2    | A    |
| $I_{CM}$  | peak collector current            |   | –    | 3    | A    |
| $I_B$     | base current (DC)                 |   | –    | 300  | mA   |
| $I_{BM}$  | peak base current                 |   | –    | 1    | A    |
| $P_{tot}$ | total power dissipation           | $T_{amb} \leq 25\text{ °C}$ ; note 3        | –    | 300  | mW   |
|           |                                   | $T_{amb} \leq 25\text{ °C}$ ; note 4        | –    | 500  | mW   |
|           |                                   | $T_{amb} \leq 25\text{ °C}$ ; note 1        | –    | 900  | mW   |
|           |                                   | $T_{amb} \leq 25\text{ °C}$ ; notes 2 and 3 | –    | 1.2  | W    |
| $T_{stg}$ | storage temperature               |   | –65  | +150 | °C   |
| $T_j$     | junction temperature              |   | –    | 150  | °C   |
| $T_{amb}$ | operating ambient temperature     |   | –65  | +150 | °C   |

**Notes**

1. Device mounted on a ceramic circuit board,  $Al_2O_3$ , standard footprint.
2. Operated under pulsed conditions: duty cycle  $\delta \leq 20\%$ , pulse width  $t_p \leq 30\text{ ms}$ .
3. Device mounted on a printed-circuit board, single-sided copper, tinplated, standard footprint.
4. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector  $1\text{ cm}^2$ .

**THERMAL CHARACTERISTICS**

| SYMBOL        | PARAMETER                                   | CONDITIONS    | VALUE | UNIT |
|---------------|---|---------------|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient | note 1        | 410   | K/W  |
|               |   | note 2        | 215   | K/W  |
|               |   | note 3        | 140   | K/W  |
|               |   | notes 1 and 4 | 110   | K/W  |

**Notes**

1. Device mounted on a printed-circuit board, single-sided copper, tinplated, standard footprint.
2. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector  $1\text{ cm}^2$ .
3. Device mounted on a ceramic circuit board,  $Al_2O_3$ , standard footprint.
4. Operated under pulsed conditions: duty cycle  $\delta \leq 20\%$ , pulse width  $t_p \leq 30\text{ ms}$ .

**Soldering**

The only recommended soldering method is reflow soldering.

40 V low  $V_{CEsat}$  NPN transistor

## PBSS4240V

**CHARACTERISTICS**

$T_{amb} = 25\text{ °C}$  unless otherwise specified.

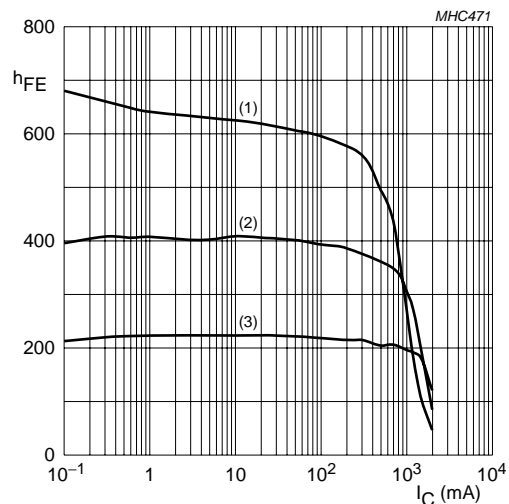
| SYMBOL      | PARAMETER                            | CONDITIONS  | MIN. | TYP. | MAX. | UNIT             |
|-------------|--------------------------------------|---|------|------|------|------------------|
| $I_{CBO}$   | collector-base cut-off current       | $V_{CB} = 40\text{ V}; I_E = 0$                                     | –    | –    | 100  | nA               |
|             |                                      | $V_{CB} = 40\text{ V}; I_E = 0; T_{amb} = 150\text{ °C}$            | –    | –    | 50   | $\mu\text{A}$    |
| $I_{CEO}$   | collector-emitter cut-off current    | $V_{CE} = 30\text{ V}; I_B = 0$                                     | –    | –    | 100  | nA               |
| $I_{EBO}$   | emitter-base cut-off current         | $V_{EB} = 5\text{ V}; I_C = 0$                                      | –    | –    | 100  | nA               |
| $h_{FE}$    | DC current gain                      | $V_{CE} = 5\text{ V}; I_C = 1\text{ mA}$                            | 300  | –    | –    |                  |
|             |                                      | $V_{CE} = 5\text{ V}; I_C = 500\text{ mA}$                          | 300  | –    | 900  |                  |
|             |                                      | $V_{CE} = 5\text{ V}; I_C = 1\text{ A}$                             | 200  | –    | –    |                  |
|             |                                      | $V_{CE} = 5\text{ V}; I_C = 2\text{ A}; \text{note 1}$              | 75   | –    | –    |                  |
| $V_{CEsat}$ | collector-emitter saturation voltage | $I_C = 100\text{ mA}; I_B = 1\text{ mA}$                            | –    | 50   | 75   | mV               |
|             |                                      | $I_C = 500\text{ mA}; I_B = 50\text{ mA}$                           | –    | 70   | 100  | mV               |
|             |                                      | $I_C = 1\text{ A}; I_B = 100\text{ mA}; \text{note 1}$              | –    | 150  | 190  | mV               |
|             |                                      | $I_C = 2\text{ A}; I_B = 200\text{ mA}; \text{note 1}$              | –    | 300  | 400  | mV               |
| $R_{CEsat}$ | equivalent on-resistance             | $I_C = 1\text{ A}; I_B = 100\text{ mA}; \text{note 1}$              | –    | 150  | <190 | $\text{m}\Omega$ |
| $V_{BEsat}$ | base-emitter saturation voltage      | $I_C = 1\text{ A}; I_B = 100\text{ mA}$                             | –    | –    | 1.2  | V                |
| $V_{BEon}$  | base-emitter turn-on voltage         | $V_{CE} = 5\text{ V}; I_C = 1\text{ A}$                             | –    | –    | 1.1  | V                |
| $f_T$       | transition frequency                 | $I_C = 50\text{ mA}; V_{CE} = 10\text{ V};$<br>$f = 100\text{ MHz}$ | 150  | –    | –    | MHz              |
| $C_c$       | collector capacitance                | $V_{CB} = 10\text{ V}; I_E = I_C = 0; f = 1\text{ MHz}$             | –    | –    | 10   | pF               |

**Note**

1. Pulse test:  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$ .

40 V low  $V_{CEsat}$  NPN transistor

## PBSS4240V



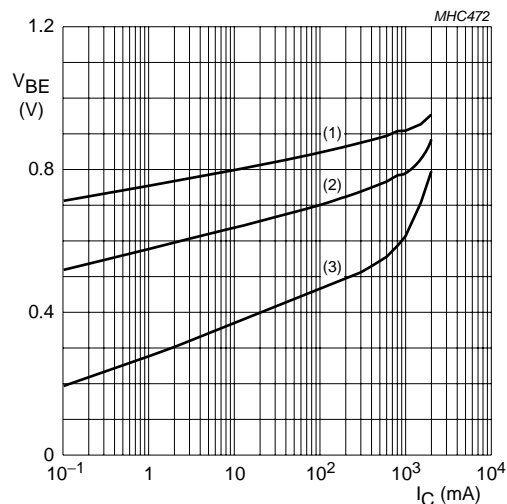
$V_{CE} = 5 \text{ V}$ .

(1)  $T_{amb} = 150 \text{ }^{\circ}\text{C}$ .

(2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .

(3)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .

Fig.2 DC current gain as a function of collector current; typical values.



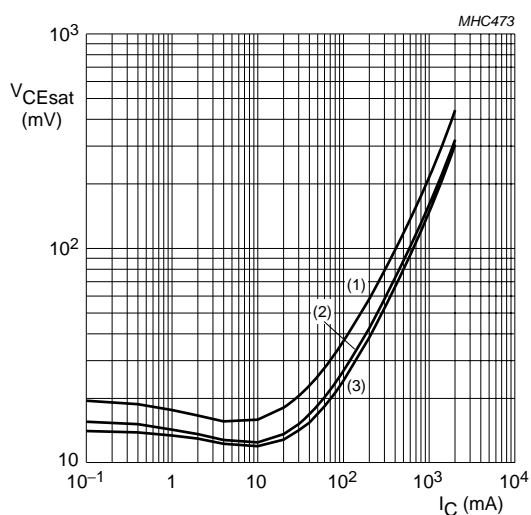
$V_{CE} = 5 \text{ V}$ .

(1)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .

(2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .

(3)  $T_{amb} = 150 \text{ }^{\circ}\text{C}$ .

Fig.3 Base-emitter voltage as a function of collector current; typical values.



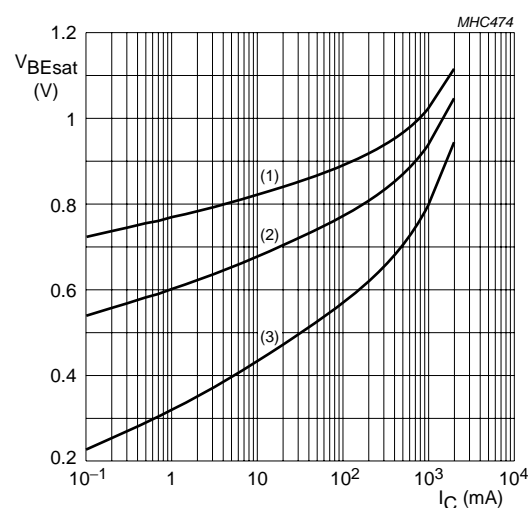
$I_C/I_B = 20$ .

(1)  $T_{amb} = 150 \text{ }^{\circ}\text{C}$ .

(2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .

(3)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



$I_C/I_B = 20$ .

(1)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .

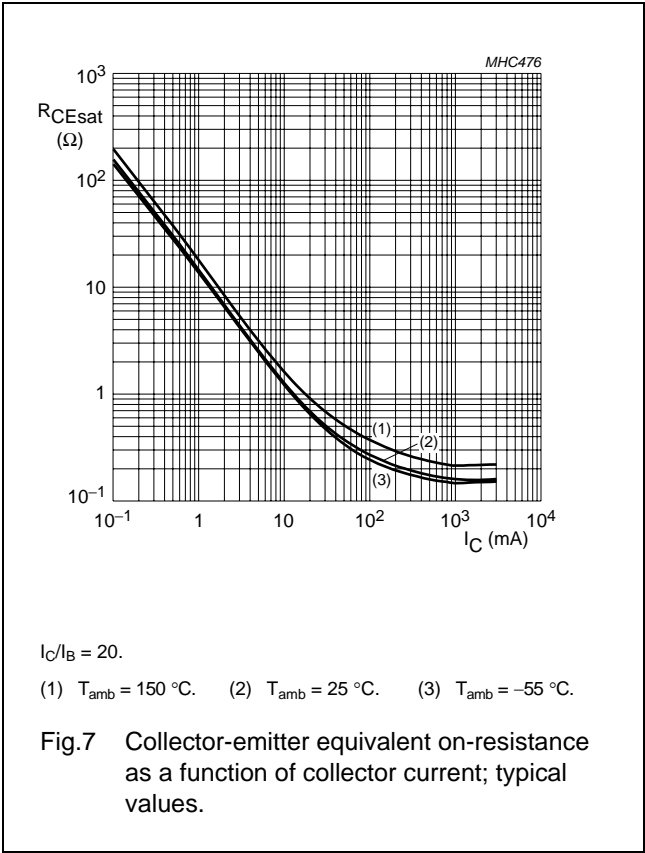
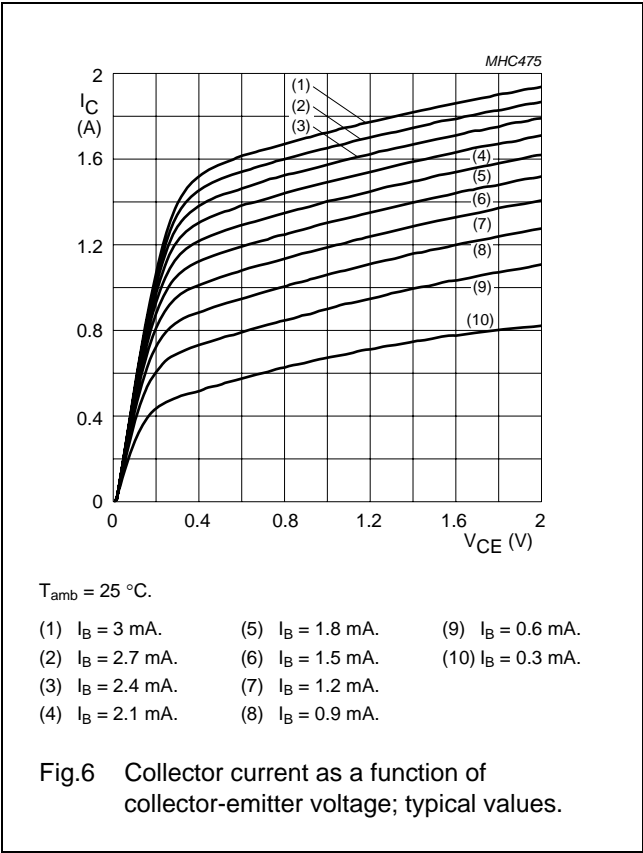
(2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .

(3)  $T_{amb} = 150 \text{ }^{\circ}\text{C}$ .

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

40 V low  $V_{CEsat}$  NPN transistor

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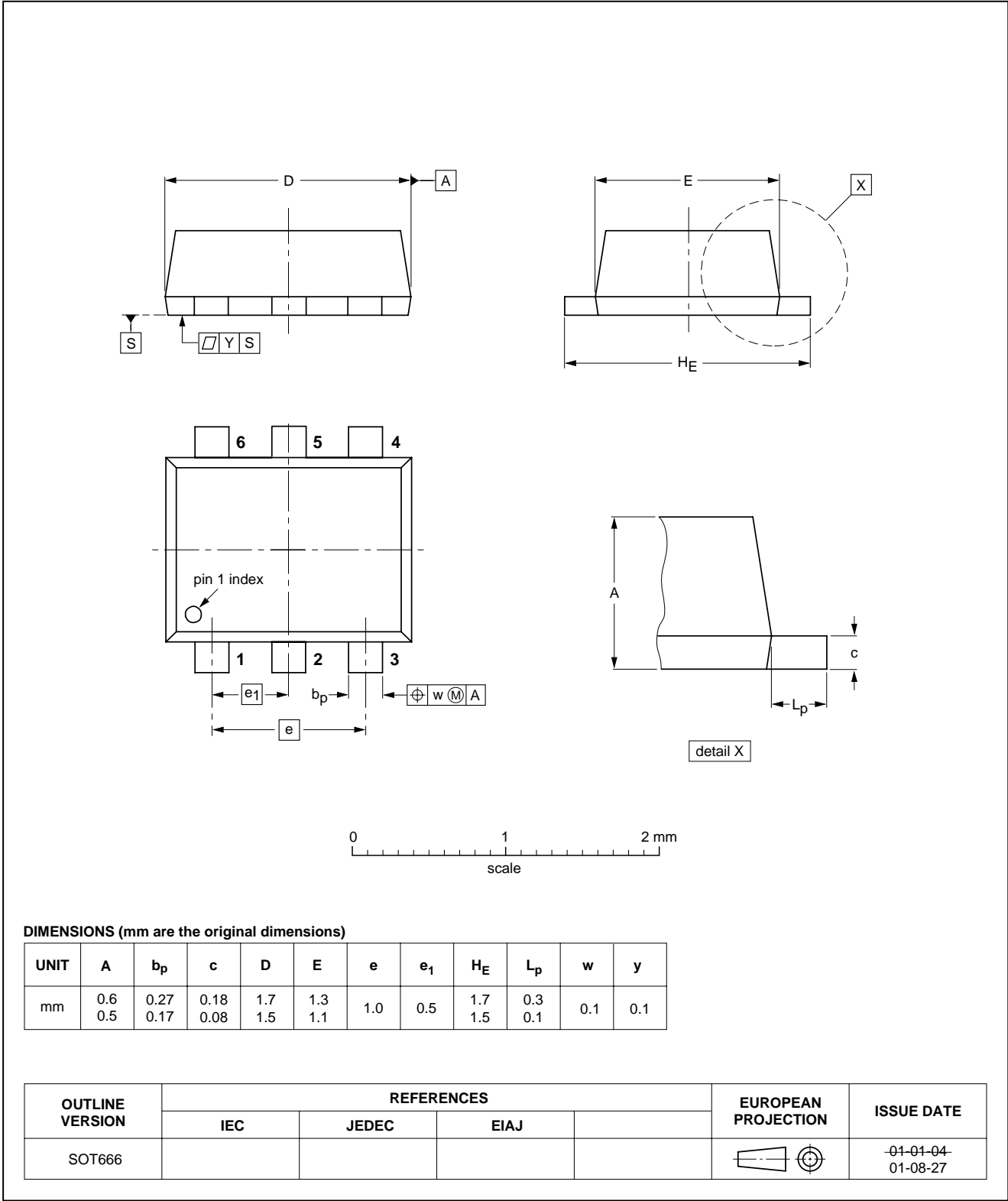
40 V low  $V_{CEsat}$  NPN transistor

PBSS4240V

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT666





40 V low  $V_{CEsat}$  NPN transistor

## PBSS4240V

## DATA SHEET STATUS

| DOCUMENT STATUS <sup>(1)</sup> | PRODUCT STATUS <sup>(2)</sup> | DEFINITION  |
|--------------------------------|-------------------------------|---|
| Objective data sheet           | Development                   | This document contains data from the objective specification for product development. |
| Preliminary data sheet         | Qualification                 | This document contains data from the preliminary specification.                       |
| Product data sheet             | Production                    | This document contains the product specification.                                     |

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# ***NXP Semiconductors***

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## **Contact information**

For additional information please visit: **<http://www.nxp.com>**

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